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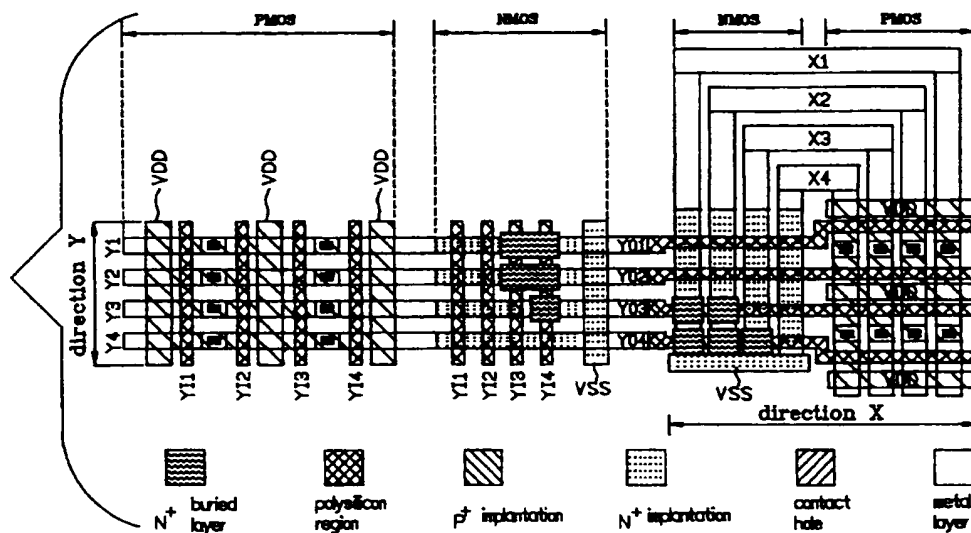
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US 5146117 A

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**(54) Flexible CMOS IC layout method**

(57) A CMOS logic IC comprising two levels of NAND gates (Figure 1) is programmed by enabling or disabling input transistors by selective ion implantation.



**Fig. 3**

**GB 2 300 983 A**

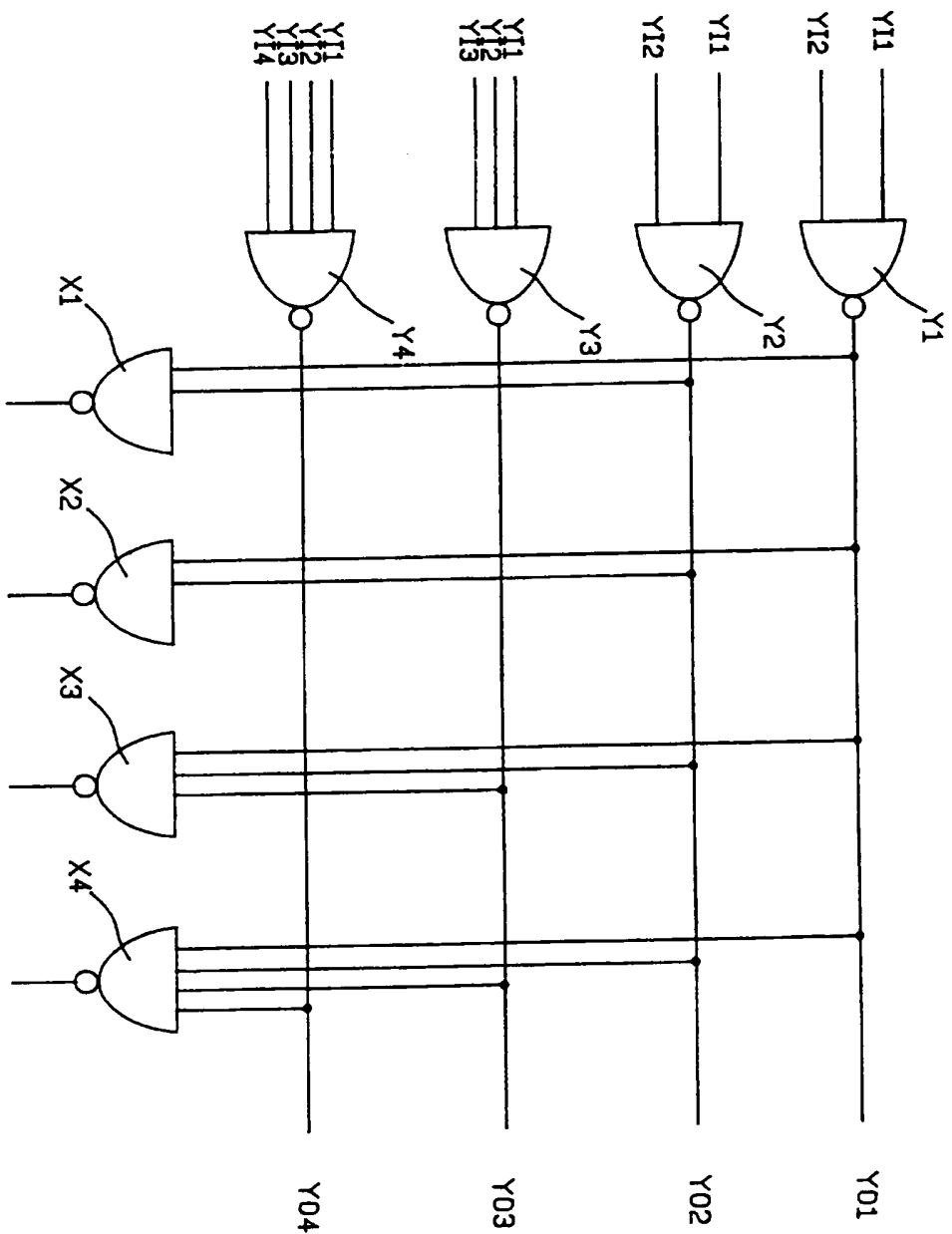


Fig. 1

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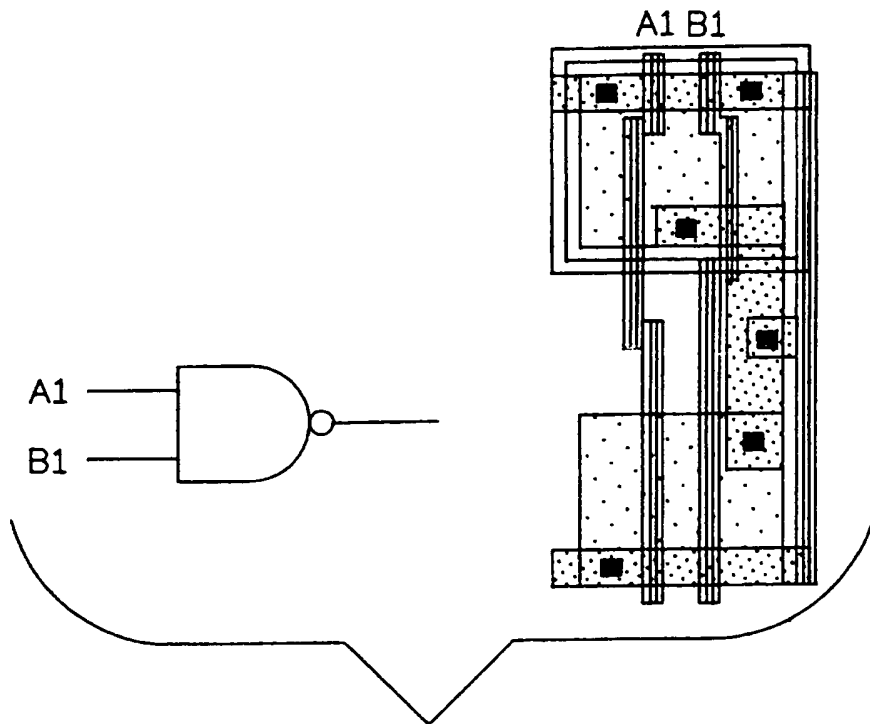


Fig. 2A

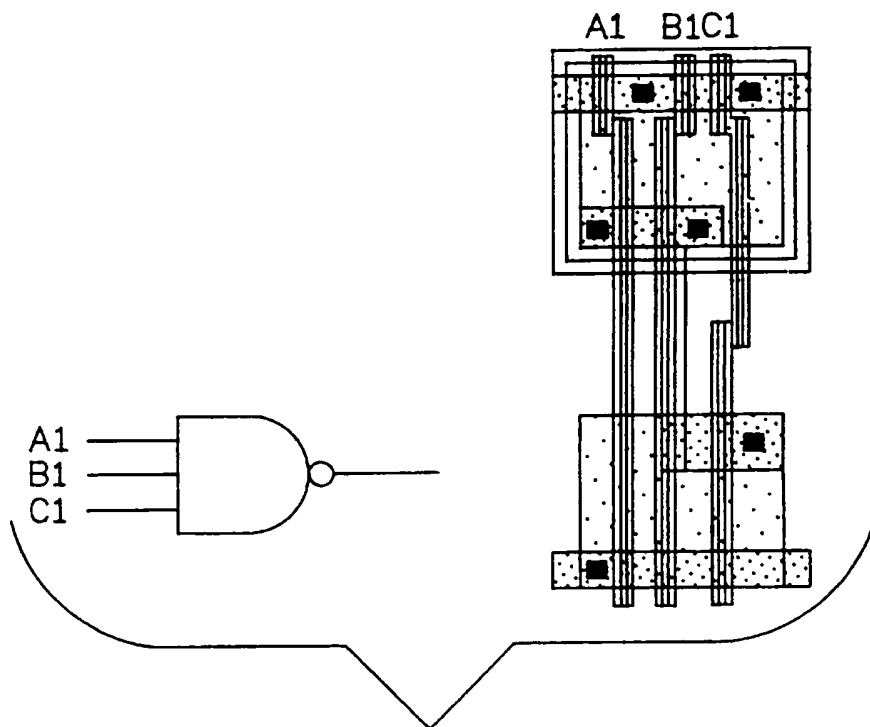


Fig. 2B

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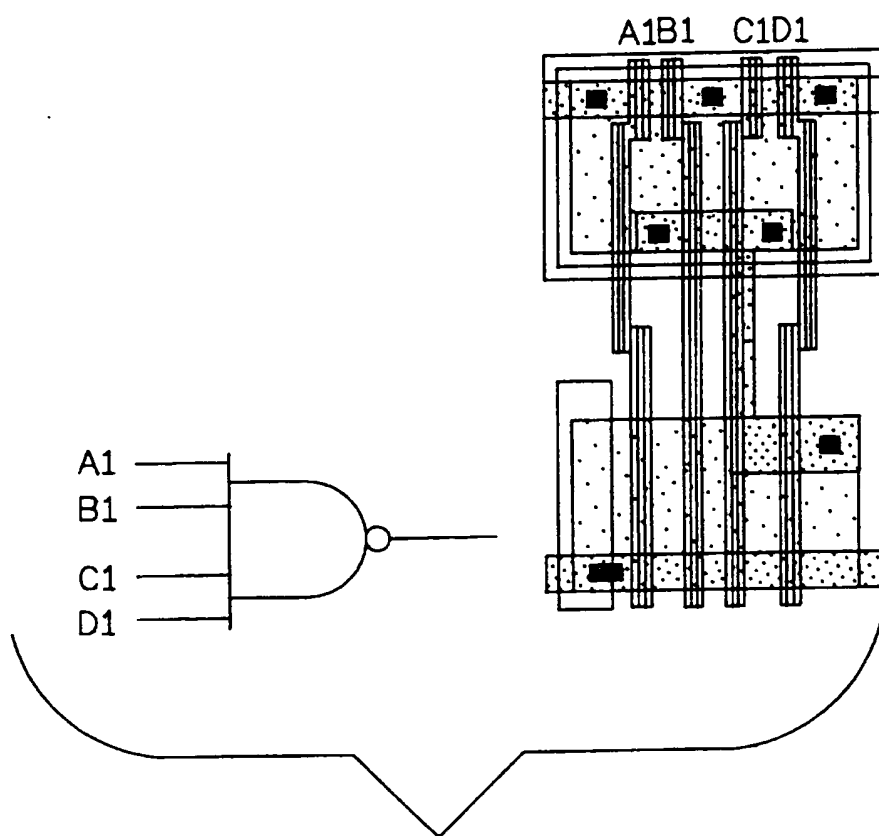


Fig. 2C

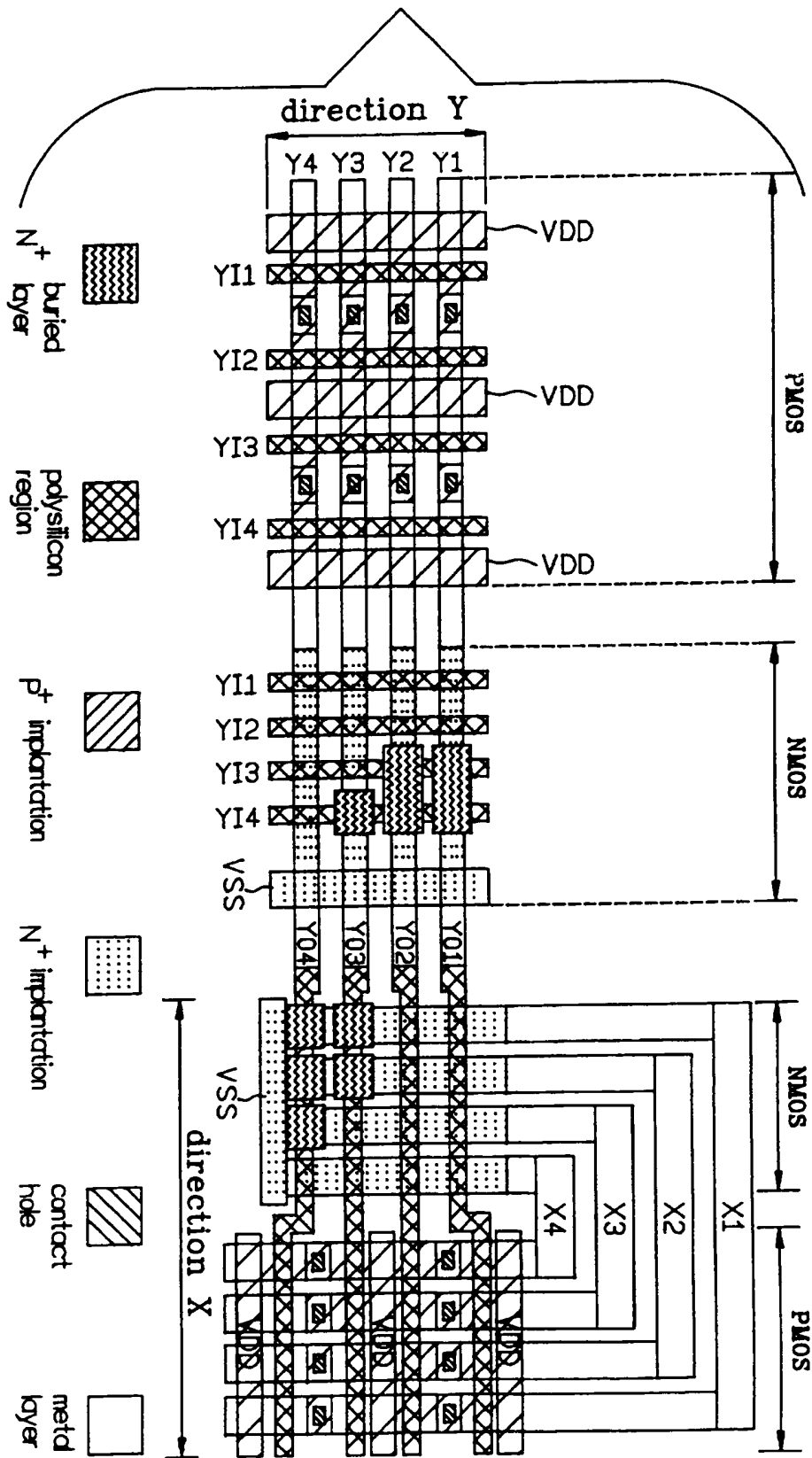


Fig. 3

## FLEXIBLE IC LAYOUT METHOD

The present invention is related to a layout method, and more particularly to an IC layout method.

5        Please refer to Fig. 1 which schematically shows four NAND gates Y1, Y2, Y3 and Y4 in the Y direction, and four NAND gates X1, X2, X3 and X4 in the X direction. The outputs Y01, Y02, Y03 and Y04 of the gates Y1~Y4 respectively serve as the inputs of the gates X1~X4. The NAND gates in the Y direction may have various numbers of input  
10       terminals. For example, as shown in Fig. 1, the gate Y1 has two input terminals YI1 and YI2, and the gates Y2, Y3 and Y4 have two (YI1, YI2), three (YI1, YI2, YI3) and four (YI1, YI2, YI3, YI4) input terminals, respectively. Likewise, the NAND gates in the X direction may also have various numbers of input terminals. In the example shown in Fig. 1, the  
15       gates X1~X4 respectively have two (Y01, Y02), two (Y01, Y02), three (Y01, Y02, Y03) and four (Y01, Y02, Y03, Y04) input terminals. The layout method utilizing the outputs of logic gates in the Y direction to serve as the inputs of logic gates in the X direction is most popular for the circuitry of an encoder or a decoder.

20       The conventional layout method is described hereinafter by giving the layout shown in Fig. 1 for example. Two cells each of which has two input terminals (Fig. 2A), one cell having three input terminals (Fig. 2B) and one cell having four input terminals (Fig. 2C) are used to serve as the gates Y1, Y2, Y3 and Y4. The same types of cells are applied to serve as  
25       the gates X1, X2, X3 and X4. Then, all of the cells are interconnected according to a certain rule.

From the aforementioned method which chooses a plurality of appropriate cells and interconnects the cells, it is obvious that the number of the input terminals in each of the gates in the conventional layout method cannot be flexibly changed after the layout has been set up. If the  
5 input terminal number of any of the gates needs to be changed, the corresponding cell in place has to be picked out of and a new cell is putted onto the circuit board. For example, if the gate Y1 having two input terminals is to be changed into one having four input terminals, the corresponding cell as shown in Fig. 2A has to be replaced by a cell as  
10 shown in Fig. 2C. However, there may be no vacancy for additional four input terminals in the original IC layout circuitry or the IC layout circuitry has to be altered to accommodate the additional input terminals. In short, the conventional layout method lacks flexibility.

An object of the present invention is to provide a flexible IC layout  
15 method.

In accordance with the present invention, a flexible IC layout method utilized for an IC having a plurality of logic gates in a first direction connected with a plurality of logic gates in a second direction wherein each of the logic gates has at least one polysilicon region and  
20 each of the logic gates in the first direction has an output serving as an input of a corresponding one of the logic gates in the second direction, includes a step of forming input terminals for the logic gates by ion implantation.

In accordance with another aspect of the invention, the logic gates  
25 in the first direction have metal layers thereof connected to the at least one polysilicon regions of the logic gates in the second direction. The first direction is perpendicular to the second direction.

In accordance with another aspect of the invention, each of the at least one polysilicon regions of the logic gates is a region capable of serving as an input terminal. The logic gates include PMOS transistors and NMOS transistors. Each of the logic gates in each direction includes  
5 at least one PMOS transistor and at least one NMOS transistor, and each of the transistors includes a polysilicon region. The polysilicon region of the PMOS transistor processed by p<sup>+</sup> implantation serves as a valid input terminal. The polysilicon region of the NMOS transistor provided with an n<sup>+</sup> buried layer serves as an invalid input terminal. A number of the valid  
10 input terminals formed on the PMOS transistors is equal to that formed on the NMOS transistors.

In accordance with another aspect of the present invention, the logic gates are NAND gates.

The present invention may best be understood through the following  
15 description with reference to the accompanying drawings, in which:

Fig. 1 is a schematic conventional logic circuit used in a conventional encoder or decoder;

Figs. 2A~2C are schematic diagrams respectively showing cells having various numbers of input terminals and used in a conventional layout  
20 method; and

Fig. 3 is a schematic diagram showing a preferred embodiment of an IC layout according to the present invention.

The present invention will now be described more specifically with reference to the following embodiments. It is to be noted that the  
25 following descriptions of preferred embodiments of this invention are presented herein for purpose of illustration and description only; it is not intended to be exhaustive or to be limited to the precise form disclosed.



Please refer to Fig. 3 which is a schematic diagram showing a preferred embodiment of an IC layout according to the present invention. The IC layout includes a plurality of NAND gates in the Y direction connected with a plurality of NAND gates in the X direction. The NAND  
5 gates in the Y direction have the metal layers thereof connected to the at least one polygate layers of the NAND gates in the X direction. The Y direction is perpendicular to the X direction. Each of the NAND gates in the Y direction has an output serving as an input of a corresponding one of the NAND gates in the X direction, and the formation of the input  
10 terminals for the NAND gates is achieved by ion implantation.

Each of the at least one polysilicon regions of the NAND gates is a region capable of serving as an input terminal. Each of the NAND gates in each direction includes PMOS transistors and NMOS transistors, and each of the transistors includes a polysilicon region. In a PMOS transistor,  
15 a valid input terminal can be made by having the polysilicon region that is on the metal layer of the PMOS transistor processed by p<sup>+</sup> implantation. In an NMOS transistor, an invalid input terminal can be provided by applying to the polysilicon region of the NMOS transistor an n<sup>+</sup> buried layer. Of course, the polysilicon regions of the NMOS transistors without  
20 applying thereto any n<sup>+</sup> buried layer serve as valid input terminals. A number of the valid input terminals formed on the PMOS transistors should be equal to that formed on the NMOS transistors.

In each of the X and the Y directions, the number of polysilicon regions of each gate is set to be equal to the number of input terminals of  
25 a gate having the most input terminals. In this preferred embodiment, the gate Y4 needs the most input terminals, 4 terminals, so each gate is set to have four polysilicon regions for choice.

As shown in Fig. 1, the gate Y1 has four polysilicon regions for serving as input terminals, but only two input terminals are required here. Thus, the first and the second polysilicon regions of the PMOS transistors of the gate Y1 are processed by  $p^+$  implantation to produce the required two valid input terminals YI1 and YI2. On the other hand, the third and the fourth polysilicon regions of the NMOS transistors of the gate Y1 are provided with  $n^+$  buried layers to make YI3 and YI4 invalid and the other two polysilicon regions are left unprocessed to produce the required two valid input terminals YI1 and YI2. Likewise, the first and the second polysilicon regions of the PMOS transistors of the gate Y2 are processed by  $p^+$  implantation to produce the required two valid input terminals YI1 and YI2. The third and the fourth polysilicon regions of the NMOS transistors of the gate Y2 are provided with  $n^+$  buried layers to make YI3 and YI4 invalid and the other two polysilicon regions are left unprocessed to produce the required two valid input terminals YI1 and YI2. Three valid input terminals YI1, YI2 and YI3 are produced by applying  $p^+$  implantation to the first, the second and the third polysilicon regions of the PMOS transistors of the gate Y3. The fourth polysilicon region of the NMOS transistor of the gate Y3 is provided with  $n^+$  buried layers to make YI4 invalid and the other three polysilicon regions are left unprocessed to produce the required three valid input terminals YI1, YI2 and YI3. All the four polysilicon regions of the PMOS transistors of the gate Y4 are processed by  $p^+$  implantation to make the input terminals YI1~YI4 valid and none of the polysilicon regions of the NMOS transistors of the gate Y4 is provided with the  $n^+$  buried layer so that the four terminals YI1~YI4 of the NMOS transistors are valid input terminals.

In the X direction, the gate X1 needs two valid input terminals Y01 and Y02, so the two polysilicon regions of the PMOS transistors of the gate X1 serving as the input terminals Y01 and Y02 are processed by p<sup>+</sup> implantation to produce the required two valid input terminals Y01 and Y02. On the other hand, the two polysilicon regions of the NMOS transistors of the gate X1 serving as the input terminals Y03 and Y04 are provided with n<sup>+</sup> buried layers to make Y03 and Y04 invalid and the other two polysilicon regions are left unprocessed to produce the required two valid input terminals Y01 and Y02. Likewise, the first and the second polysilicon regions of the PMOS transistors of the gate X2 are processed by p<sup>+</sup> implantation to produce the required two valid input terminals Y01 and Y02. The third and the fourth polysilicon regions of the NMOS transistors of the gate X2 are provided with n<sup>+</sup> buried layers to make Y03 and Y04 invalid and the other two polysilicon regions are left unprocessed to produce the required two valid input terminals Y01 and Y02. Three valid input terminals Y01, Y02 and Y03 are produced by applying p<sup>+</sup> implantation to the first, the second and the third polysilicon regions of the PMOS transistors of the gate X3. The fourth polysilicon region of the NMOS transistors of the gate X3 is provided with n<sup>+</sup> buried layers to make Y04 invalid and the other three polysilicon regions are left unprocessed to produce the required three valid input terminals Y01, Y02 and Y03. All the four polysilicon regions of the PMOS transistors of the gate X4 are processed by p<sup>+</sup> implantation to make the input terminals Y01~Y04 valid and none of the polysilicon regions of the NMOS transistors of the gate X4 is provided with the n<sup>+</sup> buried layer so that the four terminals Y01~Y04 of the NMOS transistors are valid input terminals.

To sum up, the present invention is a regular, flexible and convenient layout method. The present invention is more flexible than the prior art because the addition or deduction of the number of the input terminals according to the present invention can be achieved by ion  
5 implantation rather than by changing cells as in the prior art. By this method, an integral and regular logic circuit can be obtained.

To sum up, the present invention is a regular, flexible and convenient layout method. The present invention is more flexible than the prior art because the addition or deduction of the number of the input  
10 terminals according to the present invention can be achieved by ion implantation rather than by changing cells as in the prior art. By this method, an integral and regular logic circuit can be obtained.

## CLAIMS:

1. A flexible IC layout method utilized for an IC having a plurality of logic gates (Y1, Y2, Y3, Y4) in a first direction (Y) connected with a plurality of logic gates (X1, X2, X3, X4) in a second direction (X)  
5 wherein each of said logic gates (Y1, Y2, Y3, Y4, X1, X2, X3, X4) has at least one polysilicon region and each of said logic gates (Y1, Y2, Y3, Y4) in said first direction (Y) has an output (Y01, Y02, Y03, Y04) serving as an input of a corresponding one of said logic gates (X1, X2, X3, X4) in said second direction (X), characterized in that said method  
10 comprises a step of forming input terminals (YI1, YI2, YI3, YI4, Y01, Y02, Y03, Y04) for said logic gates (Y1, Y2, Y3, Y4, X1, X2, X3, X4) by ion implantation.
2. A method according to Claim 1, characterized in that said logic gates (Y1, Y2, Y3, Y4) in said first direction (Y) have metal layers thereof  
15 connected to said at least one polysilicon regions of said logic gates (X1, X2, X3, X4) in said second direction (X).
3. A method according to Claim 1 or 2, characterized in that said first direction (Y) is perpendicular to said second direction (X).
4. A method according to any one of Claims 1~3, characterized in that  
20 each of said at least one polysilicon regions of said logic gates (Y1, Y2, Y3, Y4, X1, X2, X3, X4) is a region capable of serving as an input terminal (YI1, YI2, YI3, YI4, Y01, Y02, Y03, Y04).
5. A method according to any one of Claims 1~4, characterized in that said logic gates (Y1, Y2, Y3, Y4, X1, X2, X3, X4) include PMOS  
25 transistors and NMOS transistors.
6. A method according to any one of Claims 1~5, characterized in that each of said logic gates (Y1, Y2, Y3, Y4, X1, X2, X3, X4) in each

direction (X, Y) includes at least one PMOS transistor and at least one NMOS transistor, and each of said transistors includes a polysilicon region.

7. A method according to Claim 6, characterized in that said polysilicon  
5 region of said PMOS transistor processed by p<sup>+</sup> implantation serves as a valid input terminal.

8. A method according to Claim 7, characterized in that said polysilicon region of said NMOS transistor provided with an n<sup>+</sup> buried layer serves as an invalid input terminal.

10 9. A method according to Claim 8, characterized in that a number of said valid input terminals formed on said PMOS transistors is equal to that formed on said NMOS transistors.

10. A method according to any one of Claims 1~9, characterized in that said logic gates (Y1, Y2, Y3, Y4, X1, X2, X3, X4) are NAND gates.

15 11. An apparatus substantially as hereinbefore described with reference to the accompanying drawings.

Patents Act 1977

Examiner's report to the Comptroller under Section 17  
(The Search report)

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Application number  
GB 9509754.9

Relevant Technical Fields

- (i) UK Cl (Ed.N) H3P (PHFC, PHFX, PHX)  
(ii) Int Cl (Ed.6) H03K 19/0944, 19/0948, 19/173

Search Examiner  
K SYLVAN

Date of completion of Search  
31 JULY 1995

Databases (see below)

- (i) UK Patent Office collections of GB, EP, WO and US patent specifications.

Documents considered relevant  
following a search in respect of  
Claims :-  
1 TO 11

(ii)

Categories of documents

- X: Document indicating lack of novelty or of inventive step. P: Document published on or after the declared priority date but before the filing date of the present application.
- Y: Document indicating lack of inventive step if combined with one or more other documents of the same category. E: Patent document published on or after, but with priority date earlier than, the filing date of the present application.
- A: Document indicating technological background and/or state of the art. &: Member of the same patent family; corresponding document.

Category	Identity of document and relevant passages	Relevant to claim(s)
A	US 5146117 (HUGHES) see Abstract and column 5 lines 32 to 38	

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